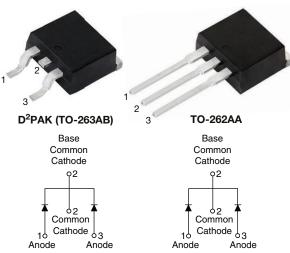
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VS-30CTH02S-M3, VS-30CTH02-1-M3

## **Vishay Semiconductors**

Hyperfast Rectifier, 30 A FRED Pt<sup>®</sup>



VS-30CTH02-1-M3

PRIMARY CHARACTERISTICS						
I <sub>F(AV)</sub>	2 x 15 A					
V <sub>R</sub>	200 V					
V <sub>F</sub> at I <sub>F</sub>	0.78 V					
t <sub>rr</sub> typ.	30 ns					
T <sub>J</sub> max.	175 °C					
Package	D <sup>2</sup> PAK (TO-263AB), TO-262AA					
Circuit configuration	Common cathode					

VS-30CTH02S-M3

#### **FEATURES**

- · Hyperfast recovery time
- · Low forward voltage drop
- Low leakage current
- 175 °C operating junction temperature
- · Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

## **DESCRIPTION / APPLICATIONS**

Vishay Semiconductors 200 V series are the state of the art rectifiers hyperfast recoverv designed with optimized performance of forward voltage drop and hyperfast recovery time.

The planar structure and the platinum doped life time control, guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in the output rectification stage of SMPS, UPS, DC/DC converters as well as freewheeling diode in low voltage inverters and chopper motor drives.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

Document Number: 96234

ABSOLUTE MAXIMUM RATINGS								
PARAMETER		SYMBOL	TEST CONDITIONS	MAX.	UNITS			
Peak repetitive reverse voltage		V <sub>RRM</sub>		200	V			
Average rectified forward current	per diode		T <sub>C</sub> = 159 °C	15				
	per device	IF(AV)		30	А			
Non-repetitive peak surge current		I <sub>FSM</sub>	T <sub>C</sub> = 25 °C	200				
Operating junction and storage ten	nperatures	TJ, T <sub>Stg</sub>		-65 to +175	°C			

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER	PARAMETER SYMBOL TEST CONDITIONS							
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA	200	-	-	V		
Converd voltage	V <sub>F</sub>	I <sub>F</sub> = 15 A	-	0.92	1.05	V		
Forward voltage		I <sub>F</sub> = 15 A, T <sub>J</sub> = 125 °C	-	0.78	0.85	v		
Povoroo lookogo ourront		$V_{R} = V_{R}$ rated	-	-	10			
Reverse leakage current	I <sub>R</sub>	$T_J = 125 \text{ °C}, V_R = V_R \text{ rated}$	-	5	300	μΑ		
Junction capacitance	n capacitance $C_T$ $V_R = 200 V$		-	57	-	pF		
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body	-	8	-	nH		

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# VS-30CTH02S-M3, VS-30CTH02-1-M3

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## **Vishay Semiconductors**

<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_C = 25$ °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	NDITIONS	MIN.	TYP.	MAX.	UNITS	
Reverse recovery time		$I_F = 1 \text{ A}, \ dI_F/dt = 50$	0 A/µs, V <sub>R</sub> = 30 V	-	-	35		
	+	$I_F = 1 \text{ A}, \text{ d}I_F/\text{d}t = 100 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	-	30	20	
	t <sub>rr</sub>	T <sub>J</sub> = 25 °C	l <sub>F</sub> = 15 A dl <sub>F</sub> /dt = 200 A/µs	-	26	-	ns	
		T <sub>J</sub> = 125 °C		-	40	-		
Pools receivers ourrent		T <sub>J</sub> = 25 °C	$V_{\rm R} = 160 \text{ V}$	-	2.8	-	А	
Peak recovery current	IRRM	T <sub>J</sub> = 125 °C		-	6.0	-		
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	37	-	nC	
		T <sub>J</sub> = 125 °C		-	120	-	110	

THERMAL - MECHANICAL SPECIFICATIONS								
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS			
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>	-65	-	175	°C			
Thermal resistance, junction to case per diode	R <sub>thJC</sub>	-	-	1.1	°C/W			
Weight		-	2.0	-	g			
Weight		-	0.07	-	oz.			
Mounting torque		6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)			
Marking davias	Case style D <sup>2</sup> PAK (TO-263AB) Case style TO-262		AK (TO-263AB)	30CTH02S				
Marking device			Case style TO-262		30CTH02-1			

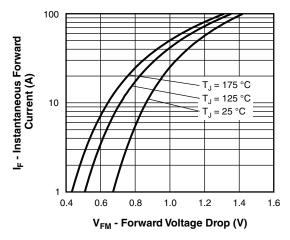


Fig. 1 - Maximum Forward Voltage Drop Characteristics

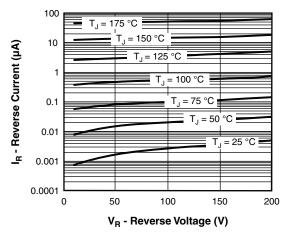


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



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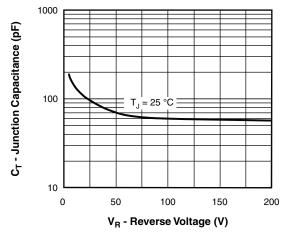


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

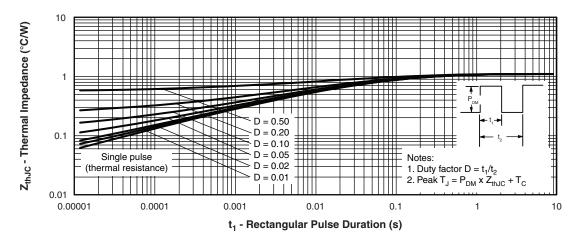


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

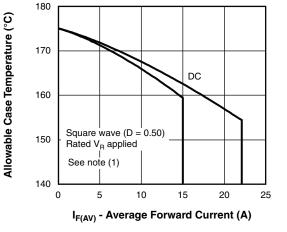


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

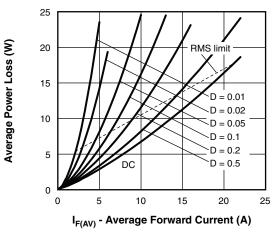


Fig. 6 - Forward Power Loss Characteristics

Revision: 21-Dec-2021

3

Document Number: 96234

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# VS-30CTH02S-M3, VS-30CTH02-1-M3

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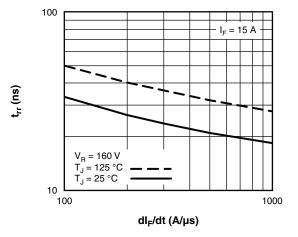


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

#### Note

- <sup>(1)</sup> Formula used:  $T_C = T_J (Pd + Pd_{REV}) \times R_{thJC}$ ;
- Pd = forward power loss =  $I_{F(AV)} \times V_{FM}$  at  $(I_{F(AV)}/D)$  (see fig. 6); Pd<sub>REV</sub> = inverse power loss =  $V_{R1} \times I_R$  (1 - D);  $I_R$  at  $V_{R1}$  = rated  $V_R$

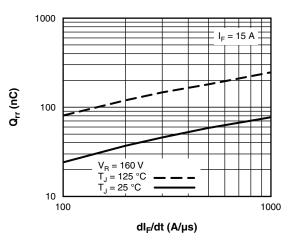


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

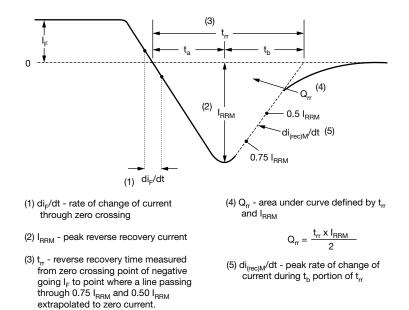


Fig. 9 - Reverse Recovery Waveform and Definitions

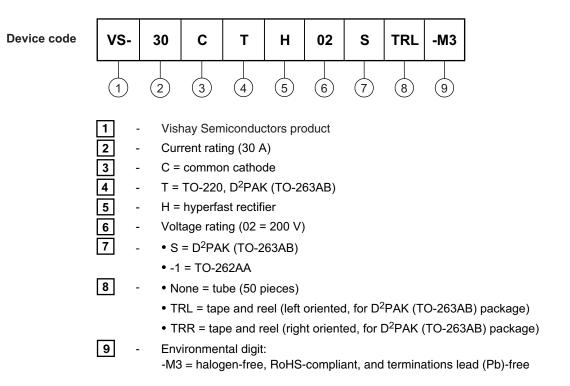


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## **ORDERING INFORMATION TABLE**

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SHAY



ORDERING INFORMATION (Example)						
PREFERRED P/N BASE QUANTITY PACKAGING DESCRI						
VS-30CTH02S-M3	50	Antistatic plastic tubes				
VS-30CTH02STRL-M3	800	13" diameter plastic tape and reel				
VS-30CTH02STRR-M3	800	13" diameter plastic tape and reel				
VS-30CTH02-1-M3	50	Antistatic plastic tubes				

LINKS TO RELATED DOCUMENTS					
Dimensions	D <sup>2</sup> PAK (TO-263AB)	www.vishay.com/doc?96164			
Dimensions	TO-262AA	www.vishay.com/doc?96165			
Part marking information	D <sup>2</sup> PAK (TO-263AB)	www.vishay.com/doc?95444			
Fart marking information	TO-262AA	www.vishay.com/doc?95443			
Packaging information		www.vishay.com/doc?96424			

Document Number: 96234

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D<sup>2</sup>PAK

#### **DIMENSIONS** in millimeters and inches



ota	ted	90	°C
<u>S</u>	cale	<u>ə:</u> 8	:1

SYMBOL	MILLIM	ETERS	INCHES		NOTES	
STMBOL	MIN.	MAX.	MIN.	MAX.	NOTES	
А	4.06	4.83	0.160	0.190		
A1	0.00	0.254	0.000	0.010		
b	0.51	0.99	0.020	0.039		
b1	0.51	0.89	0.020	0.035	4	
b2	1.14	1.78	0.045	0.070		
b3	1.14	1.73	0.045	0.068	4	
с	0.38	0.74	0.015	0.029		
c1	0.38	0.58	0.015	0.023	4	
c2	1.14	1.65	0.045	0.065		
D	8.51	9.65	0.335	0.380	2	

SYMBOL	MILLIM	MILLIMETERS		INCHES		
STNDUL	MIN.	MAX.	MIN.	MAX.	NOTES	
D1	6.86	8.00	0.270	0.315	3	
E	9.65	10.67	0.380	0.420	2, 3	
E1	7.90	8.80	0.311	0.346	3	
е	2.54 BSC		0.100 BSC			
Н	14.61	15.88	0.575	0.625		
L	1.78	2.79	0.070	0.110		
L1	-	1.65	-	0.066	3	
L2	1.27	1.78	0.050	0.070		
L3	0.25 BSC		0.010	BSC		
L4	4.78	5.28	0.188	0.208		

#### Notes

<sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5 M-1994

(2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body

(3) Thermal pad contour optional within dimension E, L1, D1 and E1

<sup>(4)</sup> Dimension b1 and c1 apply to base metal only

(5) Datum A and B to be determined at datum plane H

(6) Controlling dimension: inches

<sup>(7)</sup> Outline conforms to JEDEC<sup>®</sup> outline TO-263AB

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1

Document Number: 96164

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